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CONFIRMATION NO. 5820

<b>SERIAL NUMBER</b> 09/598,736	<b>FILING OR 371(c) DATE</b> 06/21/2000 <b>RULE</b>	<b>CLASS</b> 257	<b>GROUP ART UNIT</b> 2811	<b>ATTORNEY DOCKET NO.</b> SEL 189
<b>APPLICANTS</b> Toru Takayama, Kanagawa, JAPAN; Keiji Sato, Kanagawa, JAPAN; Shunpei Yamazaki, Tokyo, JAPAN;				
<b>** CONTINUING DATA *****</b> <u>V<sub>h</sub></u>				
<b>** FOREIGN APPLICATIONS *****</b> JAPAN 11-175937 06/22/1999 JAPAN 11-183258 06/29/1999 <b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <u>V<sub>h</sub></u> <b>** 08/22/2000</b>				
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance <u>V<sub>h</sub></u> Verified and Acknowledged _____ Examiner's Signature _____ Initials _____		<b>STATE OR COUNTRY</b> JAPAN	<b>SHEETS DRAWING</b> 28	<b>TOTAL CLAIMS</b> 63
<b>INDEPENDENT CLAIMS</b> 8				
<b>ADDRESS</b> Mark J Murphy COOK ALEX MCFARRON MANZO CUMMINGS & MEHLER LTD 200 West Adams Street Suite 2850 Chicago, IL60606				
<b>TITLE</b> Wiring material, semiconductor device provided with a wiring using the wiring material and method of manufacturing thereof				
<b>FILING FEE RECEIVED</b> 2654	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	